



杭州中有触显智能科技
Hangzhou ZoYo Chuxian Intelligent Technology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 1/32

NO: DSFN0320E002A

SPECIFICATION OF MODULE

MODULE NO: ZC-032001-0101
RoHS Complaint Product

Customer Approval:

Accept

Reject

ZOYO FOCUS	SIGNATURE	DATE
PREPARED BY	JYQ	2024.09.02
CHECKED BY	YG	2024.09.02
APPROVED BY		

Jimmy Jiang

Mobile:+86 13823181658

Email: jiangmg@zhongyou-tech.com

Company website: <https://displaysell.com/>

Hangzhou ZoYo Chuxian Intelligent Technology Co.,Ltd.

Add: 6F,No.96, Fangxingdu Street, Linping District, Hangzhou,Zhejiang, China



杭州中有触显智能科技

Hangzhou ZoYo Chuxian Intelligent Techonology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 2/32

NO: DSFN0320E002A

Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
01	A	2024.09.02	First Release.	YG



1. GENERAL DESCRIPTION:

ZC - 0320 01 - 0101

①

②

③

④

①

ZOYO Focus Brand

②

Display size: 3.189inch

③

LCM serial NO.

④

serial NO.

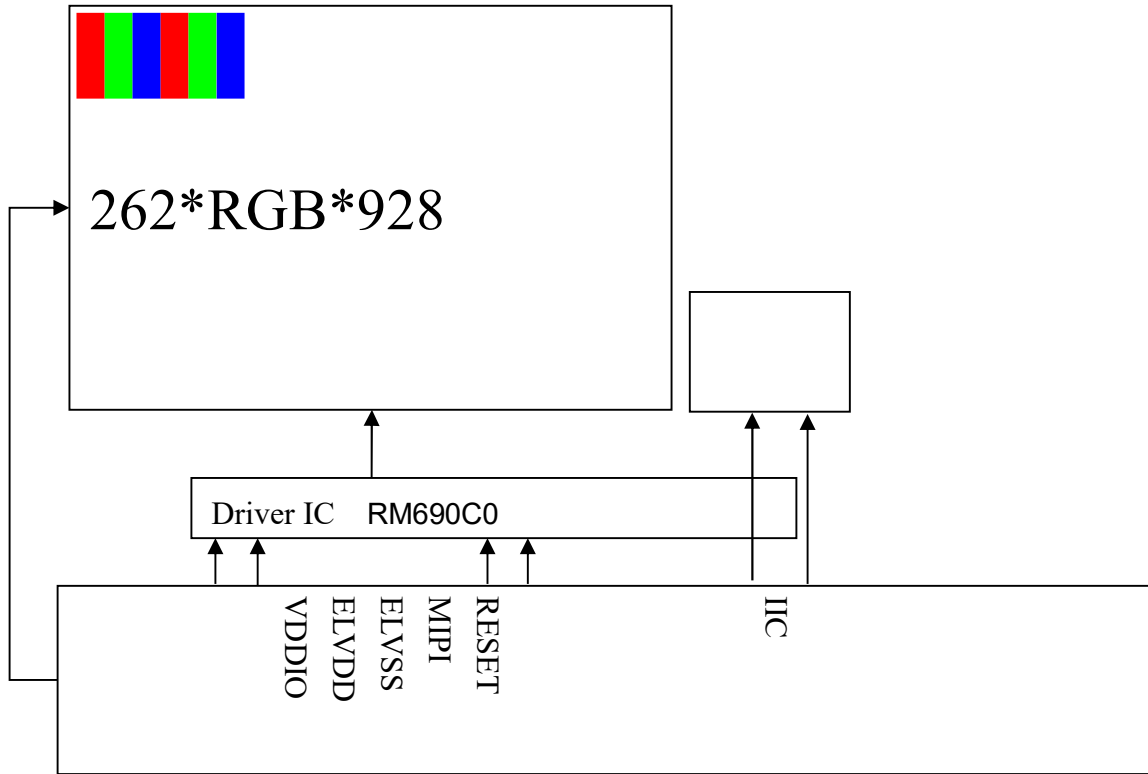
2. MECHANICAL SPECIFICATIONS:

ITEM	SPECIFICATION	Remark
Module Outline Dimension(W x H x D)(mm)	23.808(W)×81.052(H)×0.83(D)	
Active Area(mm)	22.008(H)×77.952(V)	
Pixel Pitch (um)	84(H)X84(V)	
Resolution(dot)	262(H)×928(V)	-
Driver IC(Type)	RM690C0	-
Touch IC	ZT2628	
Display Mode	AMOLED	-
Interface	MIPI	
Color Depth	16.7M	-
Luminance	500 (TYP.)	cd/m ²
Viewing Direction	ALL	-

*See attached drawing for details.



3.BLOCK DIAGRAM:





杭州中有触显智能科技

Hangzhou ZoYo Chuxian Intelligent Technology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 6/32

NO: DSFN0320E002A

5. MAIN FPC PIN DESCRIPTION:

Pin No.	Symbol	I/O	Description	Note.
1	GND	P	Ground.	
2	GND	P	Ground.	
3	LCM_CLKN	I/O	MIPI DSI Negative clock signal.	
4	VCI_EN	I	Active high enable input pin for VCI.	
5	LCM_CLKP	I/O	MIPI DSI Positive clock signal.	
6	GND	P	Ground.	
7	GND	P	Ground.	
8	LCD_IO(1.8V)	P	DIC Logic 1.8V.	
9	LCM_D1N	I	MIPI DSI Negative differential data signal.	
10	GND	P	Ground.	
11	LCM_D1P	I	MIPI DSI Positive differential data signal.	
12	LCD_RESET	I	Reset signal input.	
13	GND	P	Ground.	
14	LCM_ID	I	ID.	
15	LCM_D0N	I	MIPI DSI Negative differential data signal.	
16	GND	P	Ground.	
17	LCM_D0P	I	MIPI DSI Positive differential data signal.	
18	VCC_CTP	P	TP Power 2.8V.	
19	GND	P	Ground.	
20	GND	P	Ground.	
21	LCM_TE	O	Synchronous signal output from panel to avoid tearing effect.	
22	CTP_RESET	I	TP reset signal.	
23	VPP	P	MTP OLED.	
24	CTP_INT	I	TP INT signal.	
25	GND	P	Ground.	
26	TP_TWI2_SDA	I/O	TP I2C data.	
27	VBAT	P	PMIC input power.	
28	TP_TWI2_SCK	I	TP I2C clock.	
29	VBAT	P	PMIC input power.	
30	GND	P	Ground.	

Connector Name/Designation	Interface Connector/Interface Card
Type Part Number	OK-23GM030-04
Mating Housing Part Number	OK-23GF030-04

Note: I=Input; O=Output; P=Power; I/O=Input / Output



6. ELECTRICAL CHARACTERISTICS

6.1 Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit	Remarks
Module I/O Voltage	VDDIO	-0.3	5.5	V	
Module Operation Voltage	VCI	-0.3	5.5	V	
EL Driving Voltage	ELVDD	-0.3	5.5	V	
Driver IC Operating temperature	ELVSS	-5.5	-0.3	V	
	Topr	-40	85	°C	
Driver IC Storage temperature	Trtg	-55	125	°C	
Touch power supply voltage	TP_1.8V	-	4.0	V	
Touch Input voltage for I/O bus	-	-	4.0	V	
Touch IC Storage temperature	Tstg	-40	125	°C	

6.2 Electrical Characteristics

Parameter	Symbol	Condition	Symbol	Min.	Typ.	Max.	Uni		
ELVDD	ELVDD	Normal	-	3.25	3.3	3.35	V		
		Idle	-	3.25	3.3	3.35	V		
ELVSS	ELVSS	Normal	-	-3.25	-3.3	-3.35	V		
		Idle	-	-3.25	-3.3	-3.35	V		
VBAT	VBAT	-	-	2.9	3.7	5.0	V		
VDDIO	Vddio	-	-	1.65	1.8	3.3	V		
Power Consumption	Display on mode	IC	Vddio	100% Pixel On,500nits,60 Hz	Ivddio	-	5.1	-	mA
			Pvddio		-	9.18	-	mW	
		VBAT	Ivbat		-	99.54	-	mA	
		Pvbat	-		368.28	-	mW		
	Idle mode	IC	Vddio	10% Pixel On,50nits, 15Hz	Ivddio	-	1.02	-	mA
			Pvddio		-	1.836	-	mW	
		VBAT	Ivbat		-	10.27	-	mA	
		Pvbat	-		37.99	-	mW		
Frame Rate	F _{fm}	-40°C~85°C	F _{fm}	55.2	60	64.8	Hz		
		25°C		58.2	60	61.8	Hz		



6.3 AC Characteristics

6.3.1 DC Characteristics for MIPI DSI

Signal	Symbol	Parameter	Min.	Typ.	Max.	Unit	Note
HS_RX	V _{IDTH}	Differential input high threshold			70	mV	-
	V _{IDTL}	Differential input low threshold	-70				-
	V _{IHHS}	Single-ended input high voltage			460		1
	V _{ILHS}	Single-ended input low voltage	-40				1
	V _{CMRX(DC)}	Common-mode voltage HS receive mode	70		330		1-2
	Z _{ID}	Differential input impedance	80	100	125	Ω	-
LP_RX	V _{IL}	Logic0 voltage not in ULP State	0		550	mV	
	V _{IH}	Logic1 input voltage	880		1350	mV	
	V _{LEAK}	I/O leakage current					
LP_TX	V _{OL}	The venin output low level	-50		50	mV	
	V _{OH}	The venin output high level	1.1	1.2	1.3	V	
	Z _{OLP}	Output impedance of LP transmitter					

Notes:

- 1、Excluding possible additional RF interference of 100mV peak sine wave beyond 450MHz.
- 2、This table value includes a ground difference of 50mV between the transmitter and the receiver, the static common-mode level tolerance and variations below 450MHz.

6.3.2 MIPI DSI High-Speed RX Clock and Data-Clock Timing

Symbol	Parameter	Min.	Typ.	Max.	Unit	Notes
T _{SKEW(TX)}	Data to Clock Skew	-0.15		0.15	U _{IINST}	1
T _{SETUP}	Data to Clock Setup time	0.15			U _{IINST}	2
T _{HOLD}	Data to Clock Hold time	0.15			U _{IINST}	2
U _{IINST}	UI instantaneous	1.818		12.5	ns	3-4

Notes:

- 1、Total silicon and package delay budget of 0.3*U_{IINST}.
- 2、Total setup and hold window for receiver of 0.3*U_{IINST}.
- 3、This value corresponds to a minimum 80 Mbps data rate.
- 4、The minimum UI shall not be violated for any single bit period, i.e., any DDR half cycle within a data burst.



6.3.3 Timing Parameters:

Parameter	Description	Spec.			Unit
		Min.	Typ.	Max.	
$T_{CLK-POST}$	Time that the transmitter continues to send HS clock after the last associated Data Lane has transitioned to LP Mode. Interval is defined as the period from the end of $T_{HS-TRAIL}$ to beginning of $T_{CLK-TRAIL}$.	60ns + 52*UI			
$T_{CLK-PRE}$	Time that the HS clock shall be driver by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	8			UI
$T_{CLK-PREPARE}$	Time that the transmitter drives the Clock Lane LP-00 Line state immediately before the HS-00 Line state starting the HS transmission.	38		95	ns
$T_{CLK-TERM-EN}$	Time for the Clock Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V_{ILMAX} .			38	ns
$T_{CLK-TRAIL}$	Time that the transmitter drives the HS-00 state after the last payload clock bit of a HS HS transmission burst.	60			ns
$T_{CLK-PREPARE} + T_{CLK-ZERO}$	$T_{CLK-PREPARE}$ + Time to that the transmitter drives the HS-00 state prior to starting the clock.	300			ns
$T_{HS-EXIT}$	Time that the transmitter drives LP-11 following HS burst.	300			ns
$T_{HS-TRAIL}$	Time that the transmitter drives the flipped differential state after last payload data bit of a HS transmission burst	60ns + 4*UI			ns

6.3.4 Touch Panel I2C Timing Characteristics

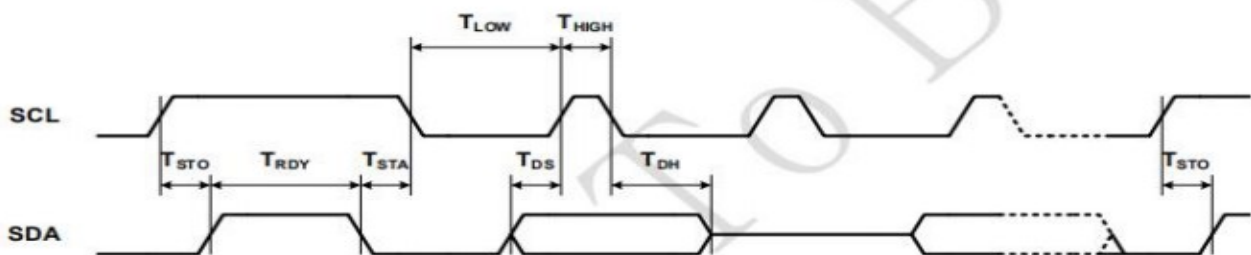


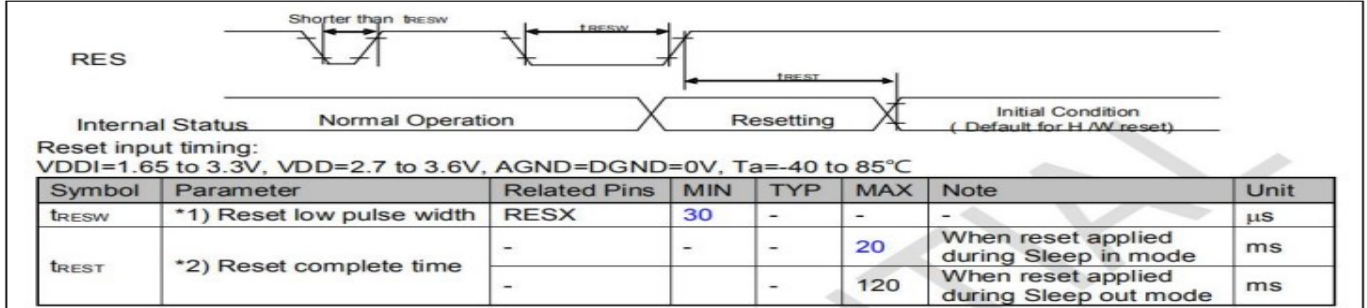
Figure 6

Table 9

SYMBOL	PARAMETER	FAST-MODE		HS-MODE		UNIT
		MIN	MAX	MIN	MAX	
F_{SCL}	SCL clock frequency	0	400	0	1000	KHz
T_{LOW}	LOW period of SCL	1300	-	500	-	ns
T_{HIGH}	HIGH period of SCL	600	-	260	-	ns
T_{STA}	Hold time for START condition	600	-	260	-	ns
T_{STO}	Setup time for STOP condition	600	-	260	-	ns
T_{DH}	Data hold time	0	900	0	900	ns
T_{DS}	Data set-up time	100	-	50	-	ns
T_{rc}	Rise time of SCL	20	300	20	120	ns
T_{fc}	Fall time of SCL	20	300	20	120	ns
T_{rD}	Rise Time of SDA	20	300	20	120	ns
T_{fD}	Fall time of SDA	20	300	20	120	ns
T_{RDY}	Ready time between STOP and START condition	20	-	20	-	us



6.3.3 Display RESET Timing Characteristics



7. RECOMMENDED OPERATING SEQUENCE

7.1 Display Power on / off Sequence

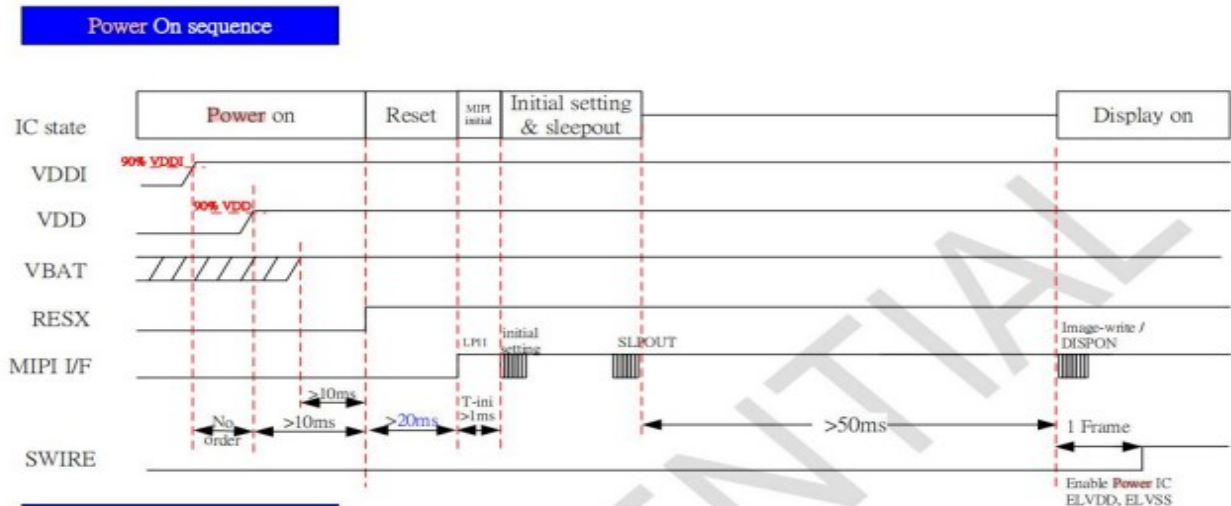


Figure 9 Power On Sequence

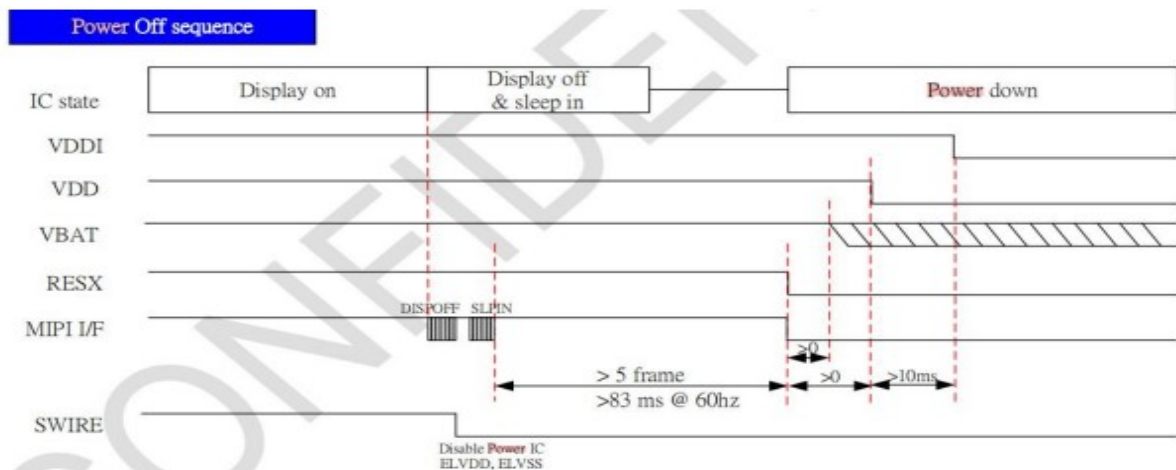
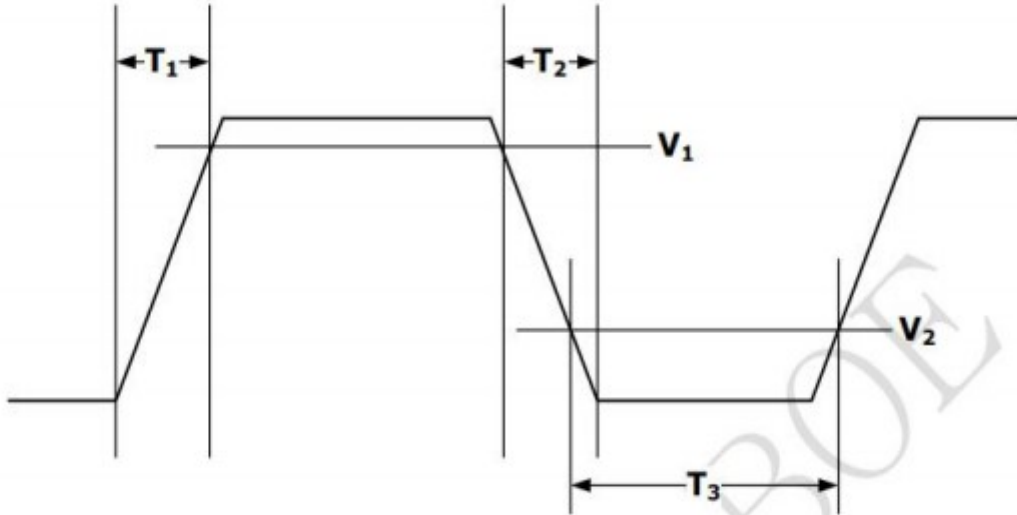


Figure 10 Power Off Sequence



7.2 Touch Panel Power on Sequence



SYMBOL	PARAMETER	MIN	MAX	UNIT
T ₁	Power-on time	-	10ms@V ₁ =2.5V	ms
T ₂	Power-off time	-	10ms@V ₂ =0.3V	ms
T ₃	From power-off to power-on time	20	-	ms

Figure 11



8. OPTICAL CHARACTERISTICS

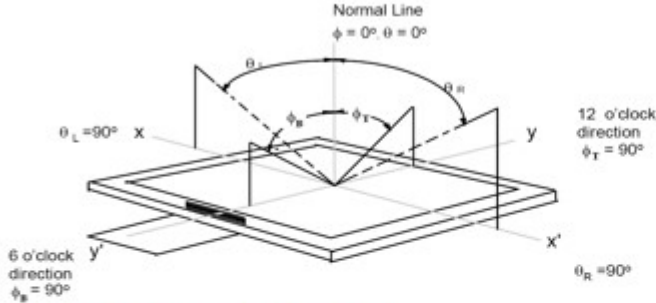
The test of optical specifications shall be measured in a dark room (ambient luminance 1 lux and temperature = 25 ± 2°C) with the equipment of the Luminance meter system (Goniometer system and TOPCON BM-5) and the test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and Φ equal to 0°. We refer to $\theta = 0^\circ$ ($= \theta = 3^\circ$) as the 3 o'clock direction (the “right”), $\theta = 90^\circ$ ($= \theta = 12^\circ$) as the 12 o'clock direction (“upward”), $\theta = 180^\circ$ ($= \theta = 9^\circ$) as the 9 o'clock direction (“left”) and $\theta = 270^\circ$ ($= \theta = 6^\circ$) as the 6 o'clock direction (“bottom”). While scanning θ and/or Φ , the center of the measuring spot on the display surface shall stay fixed.

Item	Symbol	Condition	Min	Typ.	Max	Unit	Note
Viewing Angle	θ_L	$Cr \geq 10$	80	85	--	deg	Note 1
	θ_R		80	85	--		
	ψ_T		80	85	--		
	ψ_B		80	85	--		
Contrast Ratio	Cr	$\theta = 0^\circ$	100000	--	--	--	Note 2
Response Time	$Tr + Tf$	FF = 0°	--	--	2	ms	Note 3
Color Coordinate of CIE1931	W_x	$\theta = 0^\circ$	0.285	0.300	0.315	--	Note 4
	W_y		0.295	0.310	0.325		
	R_x		0.650	0.680	0.710		
	R_y		0.290	0.320	0.350		
	G_x		0.205	0.245	0.285		
	G_y		0.675	0.715	0.755		
	B_x		0.121	0.141	0.161		
	B_y		0.023	0.043	0.063		
Uniformity	U		80	85	--	%	
Color Gamut			95	100	--	%	Note 5
OLED Lifetime		350nit T95	300	--	--	hour	



Note 1: The definition of Viewing Angle

Refer to the graph below marked by θ and ϕ .



Note 2: The definition of Contrast Ratio

$$\text{Contrast Ratio (CR)} = \frac{\text{Luminance When LCD is at "White" state}}{\text{Luminance When LCD is at "Black" state}}$$

(Contrast Ratio is measured in optimum common electrode voltage)

Note 3: Definition of Response time. (Test LCD using RD80S or similar equipments):

The output sign also photo detector are measured when the input sign also are changed from "black" to "white" (Voltage falling time) and from "white" to "black" (Voltage rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figures below.

Note 4: Color Coordinates of CIE 1931

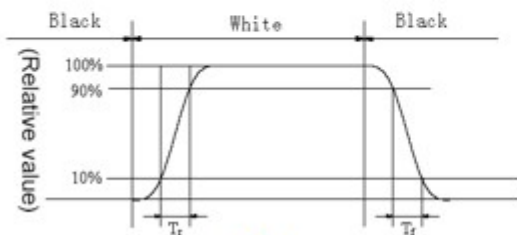
The test condition is at ILED=20mA and measured on the surface of LCD module at 25°C.

Measurement equipment: CS2000 or similar equipments

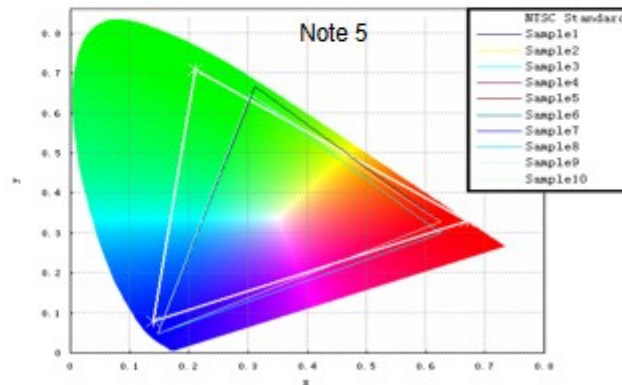
The Color Coordinate (CIE 1931) is the measurement of the center of the display shown in below figure.

Note 5: Definition of Color of CIE Coordinate and NTSC Ratio.

$$S = \frac{\text{area of RGB triangle}}{\text{area of NTSC triangle}} \times 100\%$$



Note 3



Note 5



杭州中有触显智能科技
Hangzhou ZoYo Chuxian Intelligent Techonology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 14/32

NO: DSFN0320E002A

10. PACKAGE

TBD



11. STANDARD SPECIFICATION FOR RELIABILITY:

No	Test Items	Conditions	Testing standard
1	High temperature storage Test	Ta=+80°C, 240 hours	IEC60068-2-1:2007 GB2423.2-2008
2	Low temperature storage Test	Ta=-40°C, 240 hours	IEC60068-2-1:2007 GB2423.1-2008
3	High temperature operation Test	Ta=+70°C, 240 hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low temperature operation Test	Ta=-20°C, 240 hours	IEC60068-2-1:2007 GB2423.1-2008
5	High temperature & humidity (storage Test)	Ta=+60°C, 90%RH max, 240 hours	IEC60068-2-78:2001 GB/T2423.3-2006
6	Thermal shock Test	-40°C 30min~80°C 30min, Change time:1h/cycle,100cycle	Start with cold temperature End with high temperature IEC60068-2-14:1984,GB2423.22-2002
7	ESD Test	Power Off (100pF + 1500 ohm) (Contact) ±2KV/100pF+1500 ohm	EC61000-4-2:2001 GB/T17626.2-2006 Class C
		Power On (150pF+330ohm) (Contact) ±4kv/150pF + 330 ohm (Air) ±6kv/150pF + 330 ohm	

12. QUALITY LEVEL

12.1 AMOLED Module of Characteristic Inspection

The environmental condition and visual inspection shall be conducted as below:

12.1.1 Test conditions:

OLED is not light, cold white fluorescent lamp, illumination 1000 ±200lux; OLED lighting source shall not be higher than 200lux, with black background around.

12.1.2 Inspection distance:

the standard observation distance of all surfaces of the tested object is 30cm ± 5cm.

12.1.3 Inspection angle:

the angle between the product and the horizontal plane is 45 °, and the eyes are perpendicular to the inspection plane. During inspection, the product needs to rotate 45 ° up, down, left and right. The observation line of sight needs to be within the half section of the cone. The observation angle is 45 ° with the vertical axis of the product apex. The central axis of the cone must be standard and perpendicular to the product surface and pass through the fluorescent lamp; For non-conventional display defects (including but not limited to local bright lines or local floodlights), the observation angle is 75 degrees from the normal of the product surface; Full visual angle of appearance.

12.1.4 Inspection time:



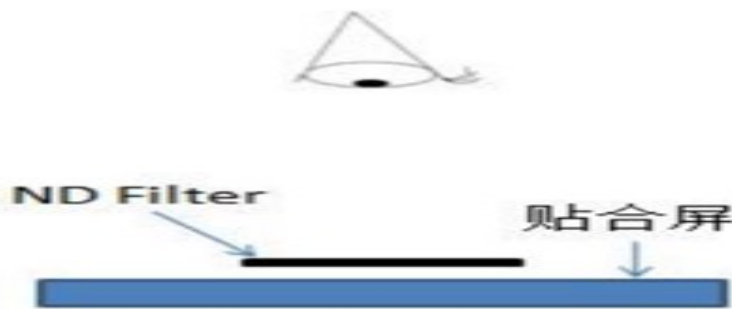
the inspection time without lighting is at least 10-12 seconds; The time of OLED lighting inspection for each picture is 1~3 seconds. If the defect is still not visible within the specified time, the inspection piece is deemed to be qualified.

12.1.5 Test temperature: room temperature 15-35 °C, ambient humidity: 20-75% RH.

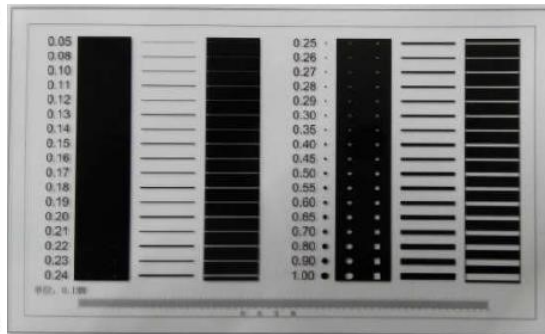
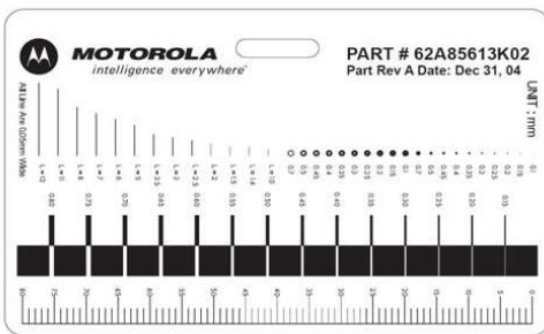
12.1.6 Inspection tools:

12.1.6.1 ND Filter:

The ND Filter is placed at a distance of 2-3 cm above the defect for 2-3s to judge whether the defect is visible. As Figure below: (ND Filter is used to test mura isochromatic and light unevenness)



12.1.6.2 Point gauge (point gauge in the figure below is recommended), determination method: as shown in the figure, the point gauge film can cover is pass, and the point gauge film can not cover is Fail. For example, a maximum of 0.2mm same-color spot defect is allowed on the Class A surface, and the pass that can be covered by 0.2mm on the film, The one that can be covered is Fail.



Imperfections of various shapes



Inspection Dot



Pass: Imperfection is smaller than the inspection dot



Fail: Imperfection is larger than the inspection dot

12.1.6.3 Microscopic examination: use 20-50 times adjustable microscope and 10-30 times test eyepiece.

12.1.6.4 Digital caliper: resolution 0.01mm.



12.1.6.5 Projector: anime microscope, 3D projector.

12.1.6.6 Judgment description:

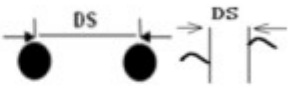

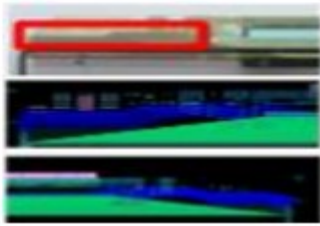



12.1.6.6.1 The measurement accuracy shall refer to the specification definition. When the measurement equipment accuracy is higher than the specification definition, the measured value needs to be rounded to the precision defined by the specification. For example, the size of edge collapse is 0.20mm, and the thousandth is the reference position, which is rounded to 0.200mm~0.204mm is OK, $\geq 0.205\text{mm}$, it is judged as NG.

12.1.6.6.2 In addition to the tools used above, if additional inspection tools are needed to assist the judgment, they can only be carried out after the coordination of both parties.

12.1.6.6.3 Bad code and definition

Code and name		legend	explain
N	Number	-	Visually calculate the number; The statistics of the total number of defects does not include the completely "omitted" part. For the column defined as "omitted" and "omitted", it is not counted as the number of defects if it meets the requirements, otherwise it is calculated as an independent defect.
L	Length (mm)		Dot line distinguishing rule: L is the long side, W is the short side A. When $L > 3W$, handle as per line, otherwise handle as per point;
W	Width (mm)		B. When it is judged as line defect, S-shaped or C-shaped line appears, and the enclosed amount is less than 3/4 circle, it shall be treated as line defect; otherwise, it shall be treated as point defect, and the inner tangent circle shall simulate the size of point.
S	Area (mm ²)	-	Surface gauge
D	Diameter (mm) $D=(L+W)/2$	-	Point diameter calculation: calculated by half of the sum of the long side and the short side, that is,

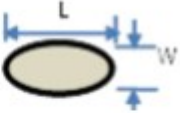
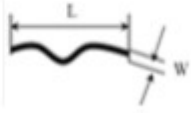

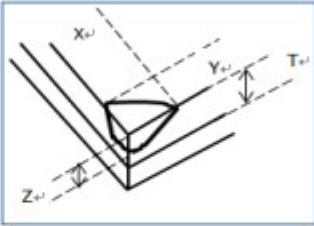


			$D=(L+W)/2$, where D represents the diameter of the point, L is the long side, and W is the short side;
H	Depth (mm)	-	Digital micrometer
DS	Distance (mm)		Distance between two points or between two lines
Schematic diagram of screen area		AA area: display area; GA area: GIP circuit area; FA area: Frit area; OA area: outside FA area	
Leader area		Screen GIP circuit area, screen data circuit area	
PAD Bonding District		COG/FOG Bonding alignment mark and Bonding Pad on LTPS substrate	
PAD Non-state area		Screen test pad, cutting area and lead-free area on LTPS substrate	
CT crimping area		Pin end screen test pad	



<p>Highlights</p>		<p>A single sub-pixel (or red, or green, or blue) of one pixel is called a point; The definition of bright spot is that in the environment of 200 ± 50 Lux, the pixels or dots seen by employees with naked eyes are always bright, and the bright spot is checked under the black screen</p>
<p>Scotoma</p>		<p>A single sub-pixel (or red, or green, or blue) of one pixel is called a point; A dark point is defined as a point that is not bright in a single sub-pixel seen with naked eyes in a 100% white picture under the environment of 200 ± 50 Lux.</p>
<p>Dark spot - two connection</p>		<p>Two adjacent sub-pixels under the magnifying glass are not bright at the same time (horizontal, vertical and oblique)</p>
<p>Dark Spot - Three Links</p>		<p>The adjacent R, G and B sub-pixels under the magnifying glass are not bright at the same time (horizontal, vertical and oblique)</p>
<p>CG monomer area division</p>		<p>AA: Front visible area, black ink internal area; A: Black ink area; B: Cover plate edge; The front defect that runs through the AA area and the A area shall be judged according to the specification of the strictest area, and the back defect shall be judged according to whether the AA area is visible.</p>
<p>Foreign matter highlights</p>	<p>-</p>	<p>Due to the foreign matter in the polarizer, the phenomenon that appears as a bright spot is called a foreign matter bright spot</p>



<p>point defect</p>		<p>There are bright spots and black spots in local positions, including but not limited to the internal dirt of the screen itself, pinholes, serrations, concave-convex spots, color spots, tiny bubbles, white spots, stains on the fitting of the polarizer, poor polarizer itself and other spot-like defects. Point defects are judged by diameter.</p>
<p>Linear defect</p>		<p>Linear impurities in the screen, including filaments, fibers, polarizer fitting impurities in the screen, and scratches on the surface of polarizer, etc. Linear defects are judged by length and width.</p> <p>Sensible scratch: also known as hard scratch, is a deep scratch on the surface, which is felt by hand.</p> <p>Senseless scratch: also known as fine scratch, no deep scratch on the surface, no feeling when touching.</p>
<p>Serrated defect</p>		<p>W: Distance from sawtooth crest to trough</p>
<p>Edge collapse/angle collapse</p>		<p>In the process of screen production, especially in the process of molding and cutting, the small glass missing at the glass edge is caused.</p> <p>X direction: parallel to FOG Pad or glass edge; Y direction: perpendicular to FOG Pad or glass edge; Z direction: screen thickness direction; T : The thickness of single-layer glass;</p>
<p>Pitting</p>	<p>-</p>	<p>In the unit area of 10mm * 10mm, the defect point with $D \leq 0.1\text{mm}$, $DS \geq 2\text{mm}$, and the number $N \geq 5$. If the customer has other requirements, follow the customer's requirements.</p>



<p>Dirty</p>	<p>-</p>	<p>Including handprints, oil stains, fingerprints, stains, white fog and other undesirable phenomena. It is divided into erasable dirt and non-erasable dirt. Use a dust-free cloth dipped in alcohol, which can not be erased as non-erasable dirt. Wipable dirt is determined as follows:</p> <p>A. Dry dust-free cloth can be directly erased;</p> <p>B. Wipe with clean cloth dipped with anhydrous alcohol</p> <p>Press the alcohol-stained dust-free cloth on the dry dust-free cloth twice to absorb excess alcohol;</p> <p>Wipe back and forth with a dust-free cloth twice, and the dirt can be removed.</p>
--------------	----------	---

12.2 Sampling Procedures for Each Item Acceptance Table

Critical Defect (CR): any defect that directly or indirectly affects human health and safety, or the function of the product is lost.

Major Defect (MA): directly or indirectly affect the product function, or make part of the product function lost, and other customers do not acceptable defects.

Minor Defect (MI): appearance defect that does not affect product function and can be accepted by customers.

Defect Type	Sampling Procedures	AQL
Critical Defect (CR)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection level II	0.065
Major Defect (MA)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection level II	0.65
Minor Defect (MI)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection level II	1.0

12.3 Telecommunications Inspection Item

category	NO.	Inspection items	Inspection specification	test mode	defect type
	1	Display exception	not allow	visual	CR



杭州中有触显智能科技

Hangzhou ZoYo Chuxian Intelligent Technology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 22/32

NO: DSFN0320E002A

Poor function	2	No display	not allow	visual	CR
	3	The picture flickers	not allow	visual	MA
TP function	4	TP test NG	not allow	visual	MA
Dot	5	Bright dot	not allow	visual	MI
	6	Partial Bright dot	ND6% or reference limit sample	visual	MI
	7	Dark dot	1.D≤0.15mm, ignored; 2.0.15mm < D≤ 0.2mm, DS ≥ 10mm, N ≤ 10; 3.D > 0.2mm,not allowed;	Visual inspection, Flinka	MI
Line	8	Bright line	not allow	visual	MA
	9	Dark line	not allow	visual	MA
	10	Slightly bright line	not allow	visual	MA
Mura	11	horizontal mura	No control under W64/127 screen; The 4%ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	12	vertical mura	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	13	White spot	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	14	Black spot	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	15	Color mura	4% ND Filter in W64/255 screen determines that the invisible is OK and the visible is NG	Visual ND Filter/limit sample	MI



	16	snowflake	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	17	Twill mura	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	18	Newtonian ring	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	MI
	19	Uneven transition	Reference homogeneity standard to assist in judgment; The 4% ND Filter in the W64/255 screen determines that the invisible product is OK and the visible product is NG.	Visual ND Filter/limit sample	MI
	<p>1、 Mura all specify the screen judgment. For example, if the ELA mura judgment standard is 255, the ELA mura will only be judged on the W255 screen.</p> <p>2、 Other types of mura have a low adverse effect rate and low incidence. According to the 4% ND Filter in the W64/255 screen, the invisible products are OK and the visible ones are NG.</p>				
Dot/line of foreign material	20	Dot/line defects (foreign material, black white dot, scratch, bubble, etc.)	Same point/line specifications	Visual inspection/Flinka	MI

12.4 Appearance Inspection Item

NO.	Inspection items	Surface Area	Inspection specification	test mode	defect type
1	Broken glass	AA/OA	not allow	visual	MA
2	crack	AA/OA	not allow	visual	MA
3	Edge collapse/corner	AA/OA	<p>1. $Y \leq 0.15\text{mm}$, X and N are ignored;</p> <p>2. $0.15 < Y \leq 0.4\text{mm}$, $X \leq 2\text{mm}$, N is ignored;</p> <p>3. $Y > 0.4\text{mm}$, not allowed;</p> <p>4. $Z \leq t$, without damage to Frit body;</p>	Visual inspection, Flinka	MI



4	flange	AA/OA	<p>1. $Y \leq 0.2\text{mm}$, X is uncontrolled; 2. $Y > 0.2\text{mm}$, not allowed;</p>	Visual inspection, Flinka	MI
5	Glass warp	Whole area	<p>The product is placed horizontally on the front and back, and the lifting height at one end (plug gauge) $\leq 0.6\text{mm}$</p>	Visual inspection, Flinka	MI
6	Pin dirty	Bongding area	No control	visual	MI
7	Pin scratch	Bongding area	Scratches and whitening are found by visual inspection, and need to be rechecked with a microscope. The broken lead is not allowed, and the overlap is not allowed Note: CT pad area and pin non-bonding area are not controlled	visual	MI
8	PF film bump	LTPS	Touch is not allowed	visual	MI
9	PF film pinholes/pits	LTPS	No control	visual	MI
10	PF film scratch	LTPS	1. No scratch, no control; Scrape through, $L < 10\text{mm}$; 2. The film shall be scraped through the exposed glass surface, referring to the lack of glue of PF film;	Visual inspection, Flinka	MI
11	PF film lacks glue	LTPS	$50 > 5\text{mm}$, $W > 5\text{mm}$ not allowed	Visual inspection, Flinka	MI
12	PF membrane is dirty	LTPS	Wipable dirt needs to be wiped, and non-wipe dirt refers to the color difference of PF film;	visual	MI
13	PF film overflow	LTPS	1. Edge overflow $W < 0.2\text{mm}$, acceptable; 2. $W > 0.2\text{mm}$, not allowed;	Visual inspection, Flinka	MI



14	Color difference/stain (no convex touch)	LTPS	No control				visual	MI
15	PF film gluing offset	LTPS	1. Step area is not allowed; 2. Except for the step area, the rest shall be controlled by $0.5 \pm 0.2\text{mm}$;				Visual inspection, Flinka	MI
16	Screen body is dirty	LTPS	1. The front can be wiped and the dirt can be wiped, and the polarizer of the dirt cover cannot be wiped; 2. The back is not controlled;				visual	MI
17	point defect	AA	D (mm)	DS (mm)	Acceptable number		Visual inspection, Flinka	MI
			$D \leq 0.15\text{mm}$	/	Ignore			
			$0.15\text{mm} < D \leq 0.2\text{mm}$	$DS \geq 10$	$N \leq 10$			
18	Linear defect/foreign matter linear/non-inductive scratch	AA	W (mm)	L (mm)	DS (mm)	Acceptable number	Visual inspection, Flinka	MI
			$W \leq 0.03$	$L \leq 5$	≥ 10	ignore		
			$0.03 < W \leq 0.05$	$L \leq 2$	≥ 10	ignore		
			$0.03 < W \leq 0.05$	$2 < L \leq 5$	≥ 10	$N \leq 4$		
			$W > 0.05$	-	/	Not allowed		
			-	$L > 5$	/	Not allowed		
19	Point/Line defects	Camera hole area/Blind hole area	D(mm)		Acceptable number		Visual inspection, Flinka	MI
			$D \leq 0.15$		ignore			
			$0.15 < D \leq 0.2$		ignore			
			$D > 0.2$					
20	Newton rings (Blind hole area)	Camera hole area/Blind hole area	Not control				Visual inspection	MI
21	offset	Camera hole	The metal ring extends inward 0.1mm ,ignore				Visual inspection	MI



杭州中有触显智能科技

Hangzhou ZoYo Chuxian Intelligent Technology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 26/32

NO: DSFN0320E002A

		area/Blind hole area			
22	Blind hole color bias(same color)	Camera hole area/Blind hole area	Functional requirements such as transmittance and PV value are met, not control appearance	Visual inspection	MI
23	Protective film scratch	Whole area	No control under no hurt baby	Visual inspection	MI
24	Protective film starved/overflow glue/burr	Whole area	No control under no hurt baby	Visual inspection	MI
25	Dirt inside the protective film	Whole area	Not allowed	Visual inspection	MI
26	Easy to tear	Cover front	Function is invalid, damaged, leaked not allowed Wrinkles, bumps, dirt, punching bad, burr, overflow glue is not controlled	Visual inspection	MI
27	Polarizer edge overflow	AA	$W \leq 0.35\text{mm}$, Not control; $W > 0.35\text{mm}$, Not allowed.	Visual inspection, Flinka	MI
28	Polarizer concave convex point	AA	convex point: $D \leq 0.2\text{mm}$ or refer to limit sample concave point: $D \leq 3\text{mm}$, $DS \geq 10\text{mm}$, $N \leq 3$ or refer to limit sample	Visual inspection, Flinka	MI
29	Polarizer fold / indentation	AA	Does not affect the display as OK or refer to limit sample;	Visual inspection	MI
30	Polarizer chromatism	AA	No control	Visual inspection	MI
31	IC chip	IC	Not allowed	Visual inspection	MI
32	FPC body defect	FPC	1. The parts on the FPC must be consistent with the product BOM table, and there are incorrect, multiple, or missing parts, which are not allowed; Polarities such as capacitors and inductors should not be soldered backwards or crooked; 2. FPC scratches/scratches are based on the absence of exposed copper; 3. Creases/Indentations: Indentations in the circuit area should not cause the back of the	Visual inspection	MI



杭州中有触显智能科技

Hangzhou ZoYo Chuxian Intelligent Technology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 27/32

NO: DSFN0320E002A

			<p>covering film to turn white; Non line area indentation should not cause FPC damage</p> <p>4. Except for the golden finger. FPC foreign object: a. Spot shape: $D \leq 0.5\text{mm}$, $N \leq 3$; b. Linear: length and width $\leq 0.3 * 5\text{mm}$;</p>		
33	FPC gold finger defect	Golden Finger Region	<p>1. Golden finger cracking: The length and width of the crack/damage at the top of the golden finger \leq the line width;</p> <p>2. Gold finger copper leakage: $W \leq 1/3$ line width, $L \leq$ line width, unlimited quantity</p> <p>3. Gold finger gap $W1 \leq 1/3$ line width W, length $L1 \leq 1/2$ line width W, unlimited quantity, all of the above conditions are met and allowed;</p> <p>4. Gold finger pressure/scratch should not expose copper, there should be no unevenness, and there should be no depth visible to the naked eye, which does not affect assembly and is acceptable;</p> <p>5. Gold fingers should not have sharp creases or dead folds;</p> <p>6. FPC gold fingers should not have oxidation, blackening, burns, or browning;</p>	Visual inspection	MI
34	connector	connect or	<p>There should be no tin or residual solder beads on the connector, and there should be no tin connection on the connector pins; PIN deformation shall be controlled within 0.05mm; Does not affect the lighting function; Visual inspection of pin breakage, pin detachment, and deformation of the outer frame is not allowed;</p>	Visual inspection	MI
35	Insulating tape	Bonding area	<p>There must be no obvious wrinkles or bubbles</p>	Visual inspection	MI
		Component area	<p>1. Scratches and glue splashes are uncontrollable;</p> <p>2. Do not wipe dirt or dirt;</p> <p>3. The offset of the insulation tape should not exceed the edge of the product, and other requirements should be determined based on the drawing;</p> <p>4. Burr edges, no control over glue overflow;</p>		



杭州中有触显智能科技

Hangzhou ZoYo Chuxian Intelligent Techonology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 28/32

NO: DSFN0320E002A

			5. Damaged, incomplete, or missing labels are not allowed;		
36	Composite tape	All	<p>1. It is not allowed for the composite tape to leak out of the edge of the screen body;</p> <p>2. Folding of composite tape, light leakage during assembly, or affecting assembly and thickness are not allowed;</p> <p>3. Damaged composite tape is not allowed;</p> <p>4. The size of the composite tape cutting defect does not meet the requirements of the drawing and cannot be controlled;</p> <p>5. Composite tape should not be wiped with dirt or foreign objects, and foreign objects should follow the dotted line standard;</p> <p>6. The burrs of the composite tape should not exceed the edge of the screen body, regardless of control;</p> <p>8. Composite adhesive tape with no control over glue splashes or overflow;</p> <p>9. Composite tape bubbles: $D \leq 5\text{mm}$, N not included;</p> <p>10. Composite tape bumps: acute angle bumps $D \leq 0.3\text{mm}$, $N \leq 3$; Smooth concave convex points $D \leq 0.8\text{mm}$, $N \leq 3$;</p> <p>11. Composite tape foreign object (foreign object between copper foil and blue film): $D \leq 0.3\text{mm}$, $N \leq 3$;</p> <p>12. Edge sawtooth of composite tape: $0.5 * 3\text{mm}$, $N \leq 3$;</p> <p>13. The color difference of the protective film in the composite tape is not controlled;</p> <p>14. Copper foil indentation and dead bending in composite tape are not allowed, which does not affect assembly and thickness control; Or reference limit sample;</p> <p>15. No control of foreign objects/dents in copper foil in composite tape;</p>	Visual inspection	MI
37	OCA overflow	All	<p>Not allowed within AA area;</p> <p>Externally visible: Control standard $\leq 0.15\text{mm}$</p>	Visual inspection	MI





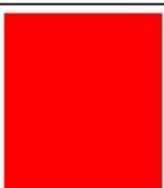
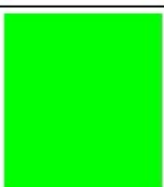



38	Sealing glue	Pin	<p>1. Broken adhesive is not allowed, and the circuit cannot be exposed.</p> <p>2. The thickness of the colloid shall not be higher than the POL surface.</p> <p>3. Bubble diameter<1mm.</p> <p>4. Other: According to the drawings and work instructions.</p>	Visual inspection	MI
39	Conductive cloth	All	<p>1. Conductive cloth dirt: $D \leq 5\text{mm}$, $N \leq 2$;</p> <p>2. Conductive cloth bubbles: $D \leq 2\text{mm}$, $N \leq 2$;</p> <p>3. Conductive cloth foreign object: $D \leq 1\text{mm}$, $N \leq 3$;</p> <p>4. Folding of conductive fabric: $N \leq 2$;</p>	Visual inspection	MI
40	Copper foil	All	<p>Copper foil sticking is not allowed to leak out of the edge of the screen body; Abnormal color of copper foil refers to standard samples/sealed samples, and damage is not allowed. Soft scratches on the surface are not controlled.</p>	Visual inspection	MI
41	QR code	QR code	<p>It is not allowed to be unable to scan or difficult to scan (recognition can only be achieved after three consecutive scans), with a clear appearance, no blurring, missing printing, and other defects</p>	Visual inspection	MI
42	Package	Other	<p>Products should put into the anti-static trays, with non-overlapping, and the trays should be staggered placed.</p>	visual	-
			<p>Different products cannot be mixed into the same inner package.</p>		
			<p>The package should not have obvious deformation or breakage .The printing labels type and quantity are correct.</p> <p>The package should have QC signature. ROHS label is needed if the product is under ROHS control.</p>		
43	Boundary dimension NG	Other	<p>It is not allowed to exceed the dimensional tolerance required by the specifications and drawings</p>	Calipers, measuring instruments	-

12.5 Inspection picture library

Serial number	picture	Picture name	Mainly judged as defective	remarks
---------------	---------	--------------	----------------------------	---------



1		W_GRAD(64) 64 gray scale	Point/line type, foreign matter point/line, mura type	/
2		W_GRAD(128) 128 gray scale	Point/line type, foreign matter point/line, mura type	/
3		WHITE white	Point/line type, foreign matter point/line, mura type	/
4		Black black	Bright spot, bright line, dark mura	/
5		RED red	Point type, line type, foreign matter point/line	/
6		GREEN green	Point type, line type, foreign matter point/line	/
7		BLUE blue	Point type, line type, foreign matter point/line	/

Note: The actual sequence and lock seconds of the screen can be adjusted according to the customer's requirements and the needs of the factory.



13. PRECAUTIONS FOR USE OF AMOLED MODULES

13.1 Handling Precautions:

- 13.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from height.
- 13.1.2 Do not press down the screen or the adjoining areas too hard because the color tone may be shifted.
- 13.1.3 The polarizer covering the display surface of the AMOLED module is soft and easily scratched. Handle this polarizer carefully.
- 13.1.4 If the display surface is contaminated, blow on the surface and gently wipe it with a soft dry cloth. If it is still not completely clear, moisten the cloth with ethyl alcohol.
- 13.1.5 Solvents may damage the polarizer. Do not use water, ketone or aromatic solvents except ethyl alcohol.
Do not attempt to disassemble the AMOLED Module.
- 13.1.6 If the logic circuit power is off, do not apply the input signals.
- 13.1.7 To prevent destruction from static electricity, be careful to maintain an optimum working environment.
- 13.1.8 Be sure to make yourself in contact with the ground when handling with the AMOLED Modules.
- 13.1.9 Tools required for assembly, such as soldering irons, must be properly ground.
- 13.1.10 To reduce the generation of static electricity, do not conduct assembly or other work under dry conditions.
- 13.1.11 To protect the display surface, the AMOLED Module is coated with a film. Be careful when peeling off this protective film, because static electricity may generate.

13.2 Storage Precautions:

- 13.2.1 When storing the AMOLED modules, be sure that they are not directly exposed to the sunlight or the light of fluorescent lamps.
- 13.2.2 The AMOLED modules should be stored under the storage temperature range. If the AMOLED modules will be stored for a long time, the recommended condition is:
Temperature: 0°C~40°C Relatively humidity: ≤80%
- 13.2.3 The AMOLED modules should be stored in the room without acid, alkali or harmful gas.

13.3 Transportation Precautions:

- 13.3.1 The AMOLED modules should not be suffered from falling and violent shocking during transportation. Besides, excessive press, water, damp and sunshine, should be avoided.



杭州中有触显智能科技
Hangzhou ZoYo Chuxian Intelligent Techonology



DISPLAY SELL

SKU.No.: DS10019

REV: A

PAGE: 32/32

NO: DSN0320E002A